

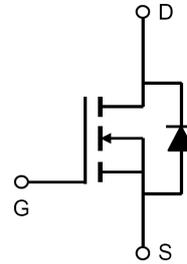
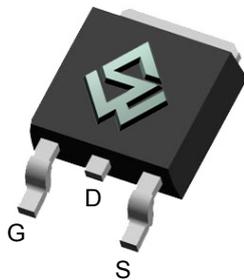
**100V Single N-Channel Enhancement-Mode MOSFET****General Description**

- 100V/60A
- Fully characterized Avalanche voltage and current.
- EAS 100% Test

Product Summary

- BV_{DSS} 100V
- $R_{DS(on)}$ @VGS = 10V < 17mΩ

TO-252 D-PAK

**Absolute Maximum Ratings** ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	± 25	V
Drain Current ($T_A=25^\circ\text{C}$)	I_D	60	A
Drain Current ($T_C=100^\circ\text{C}$)		35	A
Pulsed Drain Current ^a	I_{DM}	150	A
Single Pulse Avalanche energy ^b	E_{AS}	169	mJ
Power Dissipation ($T_C=100^\circ\text{C}$)	P_D	45	W
Junction and Storage Temperature Range	T_J, T_{STG}	-55 ~ +150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Maximum	Units
Thermal Resistance, Junction-to-Case ^c	$R_{\theta JC}$	1.1	$^\circ\text{C/W}$
Thermal Resistance Junction-Ambient	$R_{\theta JA}$	50	$^\circ\text{C/W}$

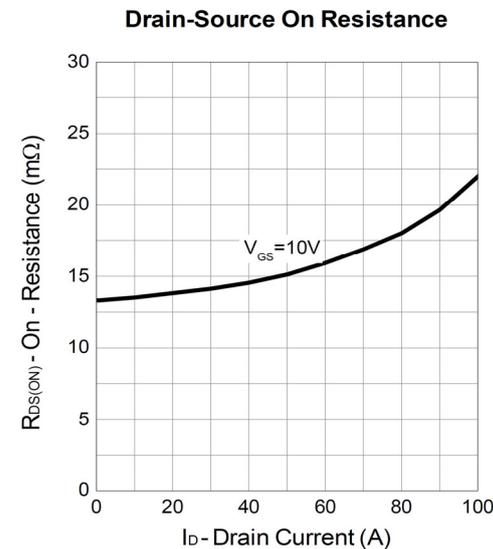
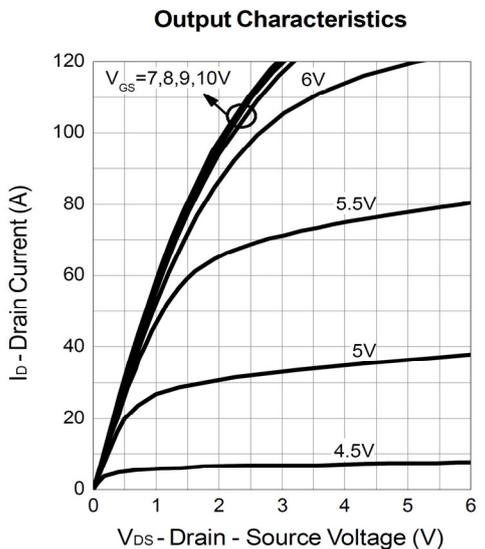
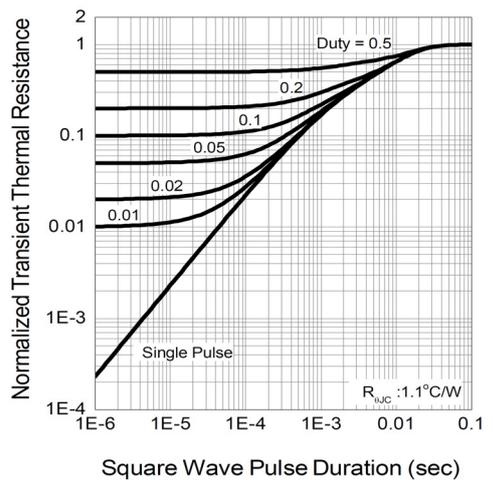
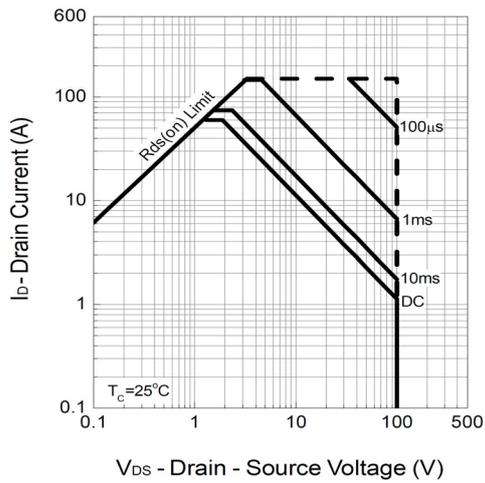
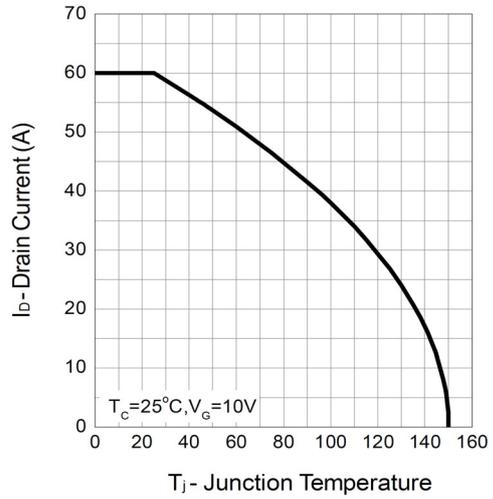
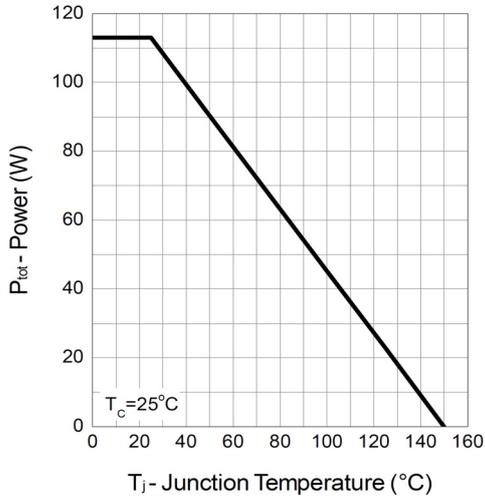


Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)						
Symbol	Parameter	Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu\text{A}$	100			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 100V, V_{GS} = 0V$			1	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS} = \pm 25V, V_{DS} = 0V$			± 100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	2	3	4	V
$R_{DS(ON)}$	Drain-Source On-State Resistance	$V_{GS} = 10V, I_D = 25A$		14	17	m Ω
Drain-Source Diode Characteristics						
V_{SD}	Diode Forward Voltage	$V_{GS} = 0V, I_S = 15A$		0.8	1.3	V
I_S	Maximum Body-Diode Continuous Current				15	A
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{DS} = 50V, V_{GS} = 0V$ $f = 1.0\text{MHz}$		2120		pF
C_{oss}	Output Capacitance			250		pF
C_{rss}	Reverse Transfer Capacitance			155		pF
Switching Characteristics						
Q_g	Total Gate Charge	$V_{DS} = 50V, I_D = 10A$ $V_{GS} = 10V$		41		nC
Q_{gs}	Gate-Source Charge			12.6		nC
Q_{gd}	Gate-Drain Charge			12.2		nC
$t_{D(ON)}$	Turn-On Delay Time	$V_{DD} = 50V, I_D = 1A$ $V_{GS} = 10V$ $R_{GEN} = 6.8\text{ohm}$		20		ns
t_r	Turn-On Rise Time			9		ns
$t_{D(OFF)}$	Turn-Off Delay Time			38		ns
t_f	Turn-Off Fall Time			22		ns

- Repetitive rating, Pulse width limited by junction temperature $T_{J(MAX)}=150^\circ\text{C}$. Ratings are based on low frequency and duty cycles to keep initial $T_J=25^\circ\text{C}$
- EAS Condition: $T_J=25^\circ\text{C}, V_{DD}=15V, V_G=10V, L=0.5\text{mH}, R_g=25\Omega$
- The value of $R_{\theta jc}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$. The value in any given application depends on the user's specific board design.

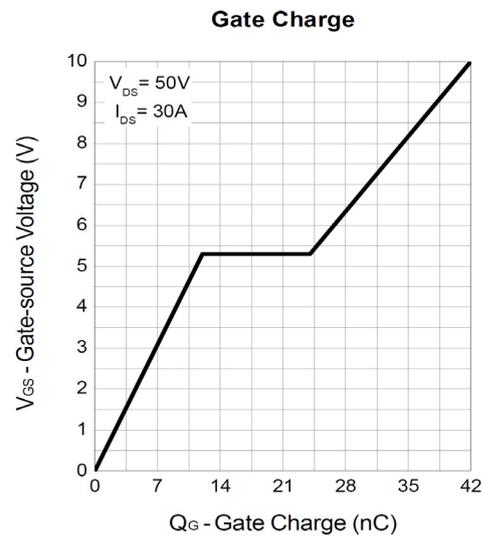
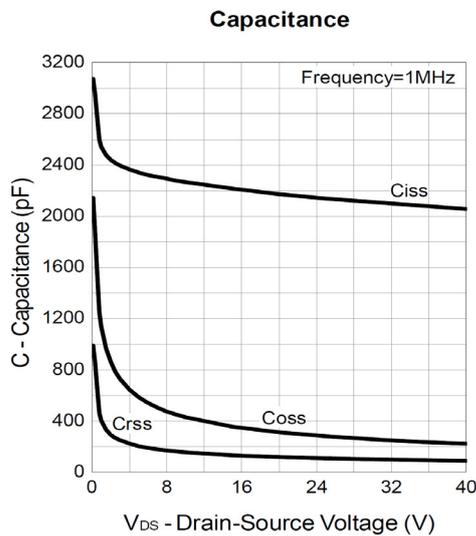
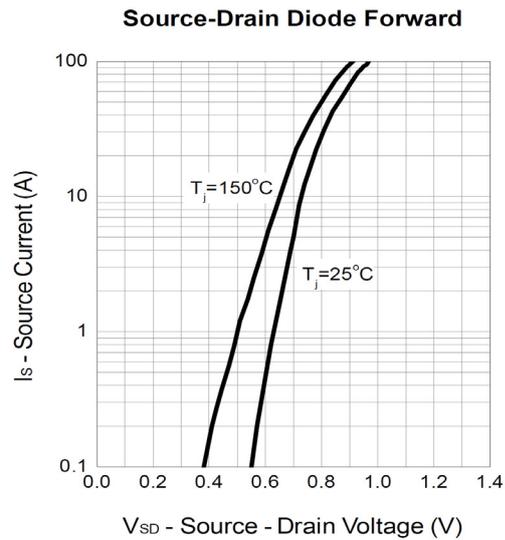
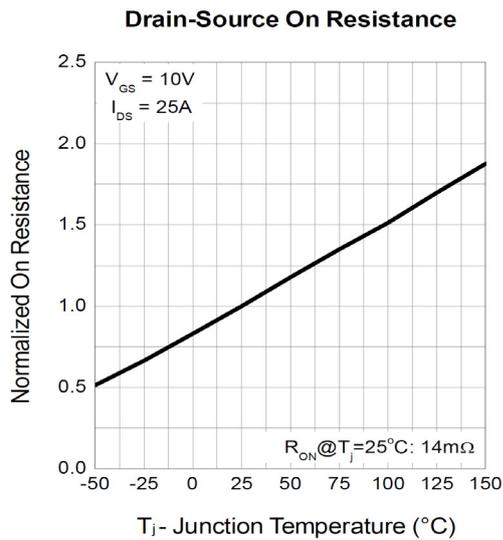
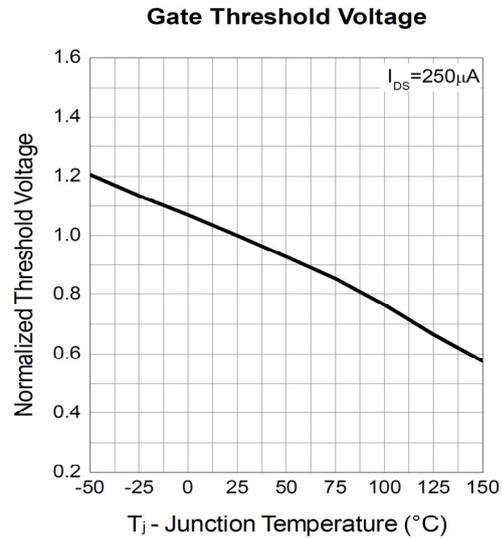
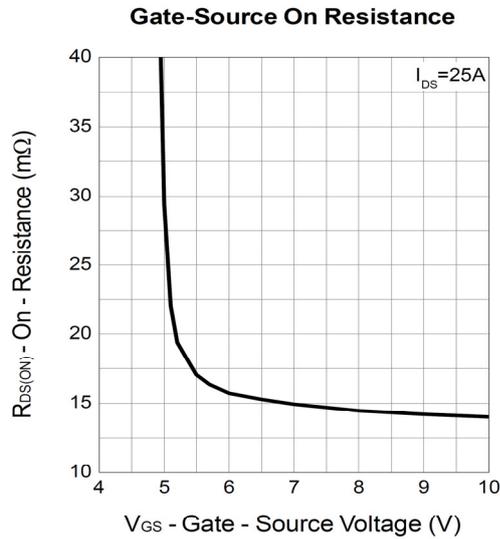


Typical Characteristics



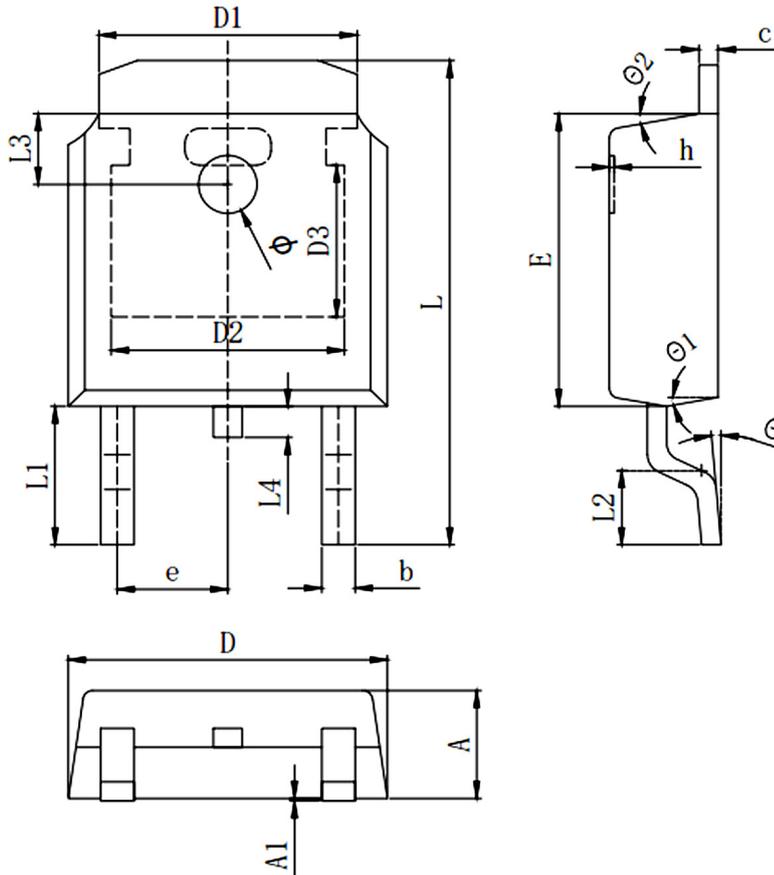


Typical Characteristics





TO-252 D-PAK Package



Symbols	Millimeters		
	MIN.	Mom.	MAX.
A	2.200	2.300	2.400
A1	0.000		0.127
b	0.640	0.690	0.740
c(电镀后)	0.460	0.520	0.580
D	6.500	6.600	6.700
D1	5.334 REF		
D2	4.826 REF		
D3	3.166REF		
E	6.000	6.100	6.200
e	2.286 TYP		
h	0.000	0.100	0.200
L	9.900	10.100	10.300
L1	2.888 REF		
L2	1.400	1.550	1.700
L3	1.600 REF		
L4	0.600	0.800	1.000
Φ	1.100	1.200	1.300
θ	0°		8°
θ_1	9° TYP		
θ_2	9° TYP		

单击下面可查看定价，库存，交付和生命周期等信息

[>>SiliconWisdom\(矽睿半导体\)](#)